### 503361177 06/23/2015

### PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT3407799

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
Hsieh-Shen Hsieh	06/22/2015
Shih-Feng Chien	06/22/2015
Yu-Lun Chang	06/22/2015
Chih-Hung Wei	06/22/2015

### **RECEIVING PARTY DATA**

Name:	CYNTEC CO., LTD.
Street Address:	No. 2, R&D 2ND RD., Science-Based Industrial Park
City:	Hsinchu
State/Country:	TAIWAN

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	14746854

#### CORRESPONDENCE DATA

**Fax Number:** (703)997-4517

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

**Phone:** 3027291562

Email: Patent.admin.uspto.cr@naipo.com

**Correspondent Name:** WINSTON HSU **Address Line 1:** P.O.BOX 506

Address Line 4: MERRIFIELD, VIRGINIA 22116

ATTORNEY DOCKET NUMBER:	CYNP0049USA
NAME OF SUBMITTER:	STEFFI CHANG
SIGNATURE:	/STEFFI CHANG/
DATE SIGNED:	06/23/2015

**Total Attachments: 8** 

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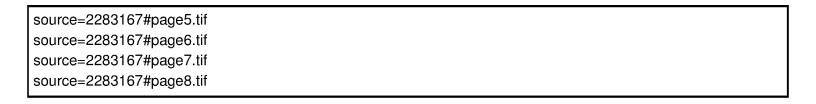
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PATENT REEL: 035951 FRAME: 0373

503361177



PATENT REEL: 035951 FRAME: 0374

## Title of Invention: METHOD OF MANUFACTURING MAGNETIC CORE ELEMENTS

As the below named inventor, I here This declaration is directed to:	by declare that:			
☑ The attached application, or				
☐ United States application nu	ımber	filed on	, ·	or
☐ PCT international application	n number	filed	on	
The above-identified application was	s made or authorized	to be made by me.		
I believe that I am the original inventapplication.	tor or an original joint	inventor of a claimed i	nvention in the	
I hereby acknowledge that any willfu under18 U.S.C. 1001 by fine or impr				
In consideration of the payment by	CYNTEC CO., LT	D.	aving a postal addre	ess of
No. 2, R&D 2ND RD., Science	-Based Industrial	Park, Hsinchu 300	)76, Taiwan, R.O	.C.
(referred to as "ASSIGNEE"below) to acknowledged, and for other good as			eipt of which is here	by
I hereby sell, assign and transfer to the entire right, title and interest in a invention as above-identified application of substitutes, or extensions thereof, and	nd to any and all impi ation and, in and to, a r any continuations, c	rovements which are d Il Letters Patent to be d ontinuation-in-part, div	isclosed in the obtained for said issions, renewals,	E
I hereby covenant that no assignme entered into which would conflict wit		r encumbrance has be	en or will be made o	r
I further covenant that ASSIGNEE wand documents relating to said inverknown and accessible to I and will to related thereto and will promptly exercise.	ntion and said Letters estify as to the same i	Patent and legal equiven any interference, litig	valents as may be	,
representatives any and all papers, maintain, issue and enforce said appequivalents thereof which may be no IN WINTNESS WHEREOF, I have h	olication, said invention ecessary or desirable	n and said Letters Pat to carry out the propos	ent and said ses thereof.	signing)
Note: An application data sheet (PT0 inventive entity, must accompany this				

Page 1 of 8

LEGAL NAME OF INVENTOR(ASSIGNOR)

Inventor: Hsieh-Shen Hsieh Date: >05.06,8>

Signature: HSIEH-SHEN

Page 2 of 8

## Title of Invention: METHOD OF MANUFACTURING MAGNETIC CORE ELEMENTS

As the below named inventor, I here This declaration is directed to:	by declare that:		
☑ The attached application, or			
☐ United States application nu	mber	filed on	, or
☐ PCT international application	n number	filed on	
The above-identified application was	s made or authorized to be ma	de by me.	, , , , , , , , , , , , , , , , , , , ,
I believe that I am the original invent application.	or or an original joint inventor	of a claimed invention	in the
I hereby acknowledge that any willfu under18 U.S.C. 1001 by fine or impri	I false statement made in this isonment of not more than five	declaration is punishabe (5) years, or both.	ole
In consideration of the payment by	CYNTEC CO., LTD.	having a p	ostal address of
No. 2, R&D 2ND RD., Science-	-Based Industrial Park, H	lsinchu 30076, Tai	wan, R.O.C.
(referred to as "ASSIGNEE"below) to acknowledged, andfor other good an	o I of the sum of One Dollar (\$ ad valuable consideration.	1.00), the receipt of wh	hich is hereby
I hereby sell, assign and transfer to A the entire right, title and interest in an invention as above-identified application or substitutes, or extensions thereof, an	nd to any and all improvement tion and, in and to, all Letters rany continuations, continuation	s which are disclosed i Patent to be obtained f on-in-part, divisions, re	n the or said newals.
I hereby covenant that no assignment entered into which would conflict with	nt, sale, agreement or encumb n this assignment;	rance has been or will	be made or
I further covenant that ASSIGNEE wi and documents relating to said inven known and accessible to I and will te related thereto and will promptly exec	tion and said Letters Patent a stify as to the same in any inte	nd legal equivalents as erference, litigation prod	mav be
representatives any and all papers, ir maintain, issue and enforce said app equivalents thereof which may be ned IN WINTNESS WHEREOF, I have he	lication, said invention and sa cessary or desirable to carry o	id Letters Patent and so out the proposes thereo	aid vf. (Date of signing) —
Note: An application data sheet (PTC			

Page 3 of 8

LEGAL NAME OF INVENTOR(ASSIGNOR)				
Inventor:	Shih-Feng Chien	Date:	2015.06x2	
Signature:	Shih-Feng Clien			and the second

### Title of Invention: METHOD OF MANUFACTURING MAGNETIC CORE ELEMENTS

As the below named inventor, I here This declaration is directed to:	eby declare that:		
☑ The attached application, or			
☐ United States application nu	mber	filed on	, or
☐ PCT international application	n number	filed on	
The above-identified application was	s made or authorized to	be made by me.	***************************************
I believe that I am the original invent application.	or or an original joint in	ventor of a claimed invention in	ı the
I hereby acknowledge that any willfu under18 U.S.C. 1001 by fine or impr	l false statement made isonment of not more tl	in this declaration is punishable nan five (5) years, or both.	le
In consideration of the payment by	CYNTEC CO., LTD	having a po	ostal address of
No. 2, R&D 2ND RD., Science-	-Based Industrial P	ark, Hsinchu 30076, Taiw	/an, R.O.C.
(referred to as "ASSIGNEE"below) to acknowledged, andfor other good an	o I of the sum of One D nd valuable consideration	ollar (\$ 1.00), the receipt of wh n.	ich is hereby
I hereby sell, assign and transfer to A the entire right, title and interest in ar invention as above-identified applica- invention by the above application or substitutes, or extensions thereof, an	nd to any and all improvition and, in and to, all L any continuations, con	rements which are disclosed in etters Patent to be obtained fo tinuation-in-part, divisions, ren	the r said ewals
I hereby covenant that no assignmer entered into which would conflict with	nt, sale, agreement or e n this assignment;	ncumbrance has been or will b	e made or
I further covenant that ASSIGNEE wi and documents relating to said inven known and accessible to I and will te related thereto and will promptly exec	tion and said Letters Pa stify as to the same in a	atent and legal equivalents as a any interference, litigation proce	mav be
representatives any and all papers, ir maintain, issue and enforce said app equivalents thereof which may be ned IN WINTNESS WHEREOF, I have he	lication, said invention a	and said Letters Patent and sa	id (Date of signing)
Note: An application data sheet (PTC nventive entity, must accompany this	0/SB/14 or equivalent), s form. Use this form fo	ncluding naming the entire each additional inventor.	

Page 5 of 8

F#NPO-P0002E-US1201

LEGAL NAME OF INVENTOR(ASSIGNOR)					
Inventor:	Yu-Lun Chang	Date:	2015.6.22		
Signature:	Yu-lun, Chang				

Page 6 of 8

# Title of Invention: METHOD OF MANUFACTURING MAGNETIC CORE ELEMENTS

United States application number filed on , or	As the below named inventor, I here This declaration is directed to:	by declare that:		
PCT international application number  The above-identified application was made or authorized to be made by me.  I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.  I hereby acknowledge that any willful false statement made in this declaration is punishable under18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.  In consideration of the payment by CYNTEC CO., LTD. having a postal address of No. 2, R&D 2ND RD., Science-Based Industrial Park, Hsinchu 30076, Taiwan, R.O.C. (referred to as "ASSIGNEE"below) to I of the sum of One Dollar (\$ 1.00), the receipt of which is hereby acknowledged, andfor other good and valuable consideration.  I hereby sell, assign and transfer to ASSIGNEE and the successors and assignees of the ASSIGNEE the invention as above-identified application and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof.  I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;  I further covenant that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to I and will testify as to the same in any interference, litigation proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidiavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said aquivalents thereof which may be necessary or desirable to carry out the proposes thereof. N WINTNESS WHEREOF, I have hereunto set hand and seal this	☑ The attached application, or			
The above-identified application was made or authorized to be made by me.  I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.  I hereby acknowledge that any willful false statement made in this declaration is punishable under18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.  In consideration of the payment by CYNTEC CO., LTD. having a postal address of No. 2, R&D 2ND RD., Science-Based Industrial Park, Hsinchu 30076, Taiwan, R.O.C. (referred to as "ASSIGNEE"below) to I of the sum of One Dollar (\$ 1.00), the receipt of which is hereby acknowledged, andfor other good and valuable consideration.  I hereby sell, assign and transfer to ASSIGNEE and the successors and assignees of the ASSIGNEE the entire right, title and interest in and to any and all improvements which are disclosed in the invention as above-identified application and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof.  I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;  I further covenant that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to I and will testify as to the same in any interference, litigation proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said Letters Patent and said squivalents thereof which may be necessary or desirable to carry out the proposes thereof.  N WINTNESS WHERE	☐ United States application nu	mber	filed on	, or
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Page 7 of 8

NPO#CYN-P0049-USA:0 CUST#RD-103011-US

Inventor: Chih-Hung Wei

Signature: Mallang Mei

Date: 6/22/5

Page 8 of 8

NPO#CYN-P0049-USA:0 CUST#RD-103011-US

**RECORDED: 06/23/2015**